



#17/Amend C
4/17/03
C.P.

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Chien-Ping HUANG

Serial No.: 09/665,818

Group No.: 2814

Filed: September 20, 2000

Examiner: Dana Farahani

For: SEMICONDUCTOR PACKAGE FOR ENHANCING
HEAT DISSIPATION

Attorney Docket No.: U 013803-1

Assistant Commissioner of Patents
Washington, D.C. 20231

Sir:

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TECHNOLOGY CENTER 2800

FIRST AMENDMENT AFTER FINAL REJECTION

In response to the Official Action of November 8, 2002, it is requested
that the following amendments be made.

IN THE CLAIMS

Amend claim 1 as follows:

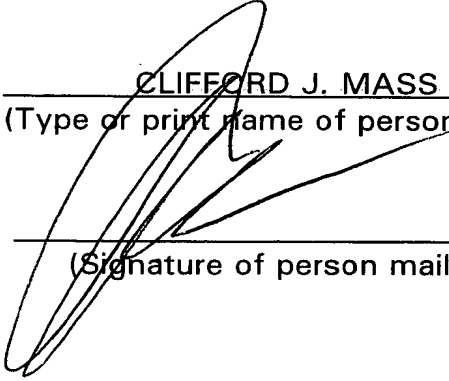
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